Specifications for Approval

Customer Part No.:

	: S2012CHRGBT-001 2 红绿蓝三色 LED	
Spec Issue Date	: 2018-07-13	
Revision No.: A		
To Customer: We submit herewith the followin ■ Sample □ OQC Ir ■ Electrical Characteristics Cu ■ Soldering recommendation Prepared by: Lily Date: 2018-07-13	nspection Record rve Internal Circu	LED Dimension
Customer Opinion Approve and no objection Reject with the following rea	son:	



东莞市银河光电有限公司
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Features

2.0mm x 1.25mm SMD LED, 0.8mm thickness

Low power consumption

Wide view angle

Package: 3000pcs/reel

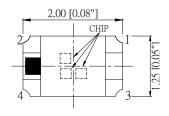
RoHS Compliant

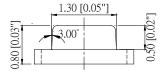
Applications

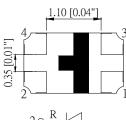
Ideal for back light and indicator

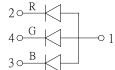
Various colors and lens types available

Package outlines

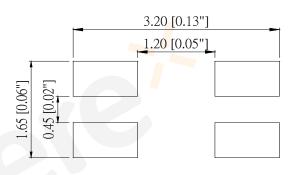








Recommend Pad Layout





Part No.	Emitted color	Dice Material	Lens color
	Red	AlGaInP	
S2012CHRGBT-001	Green	InGaN/GaN	Water transparent
	Blue	InGaN/GaN	

Notes:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are ± 0.1 mm (0.004inch) unless otherwise noted.

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Absolute Maximum Ratings (Ta=25°C)

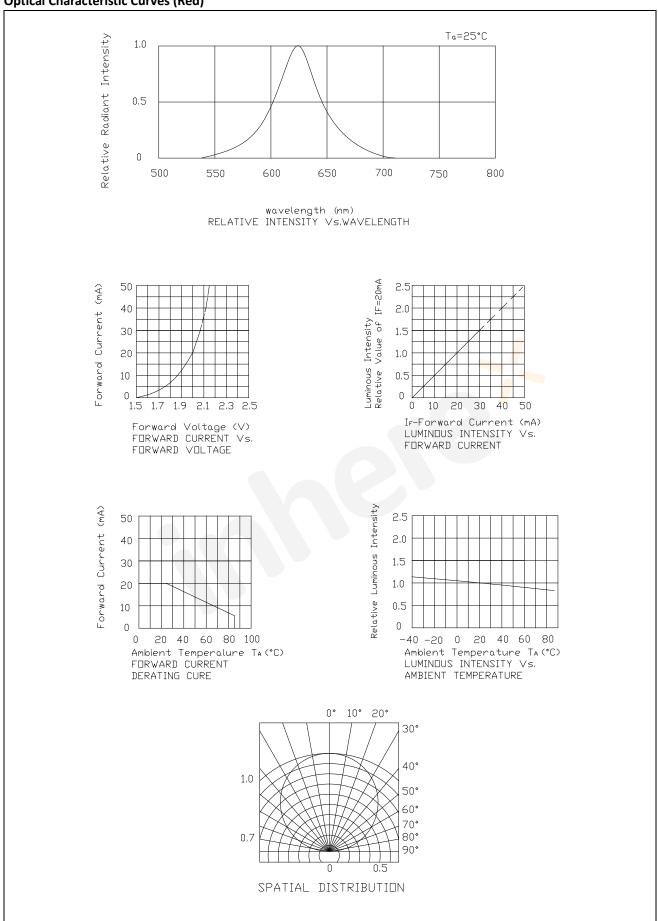
Downston	Parameter Symbol	Value			l lait
Parameter		R	G	В	Unit
Power dissipation	Pd	72	111	111	mW
Forward current	If	30			mA
Reverse voltage	Vr	5			V
Operating temperature	Тор	-40 ~+80)	$^{\circ}\!$
Storage temperature	Tstg	-40 ~+85		5	$^{\circ}$
Peak pulsing current (1/8 duty f=1kHz)	Ifp		125		mA

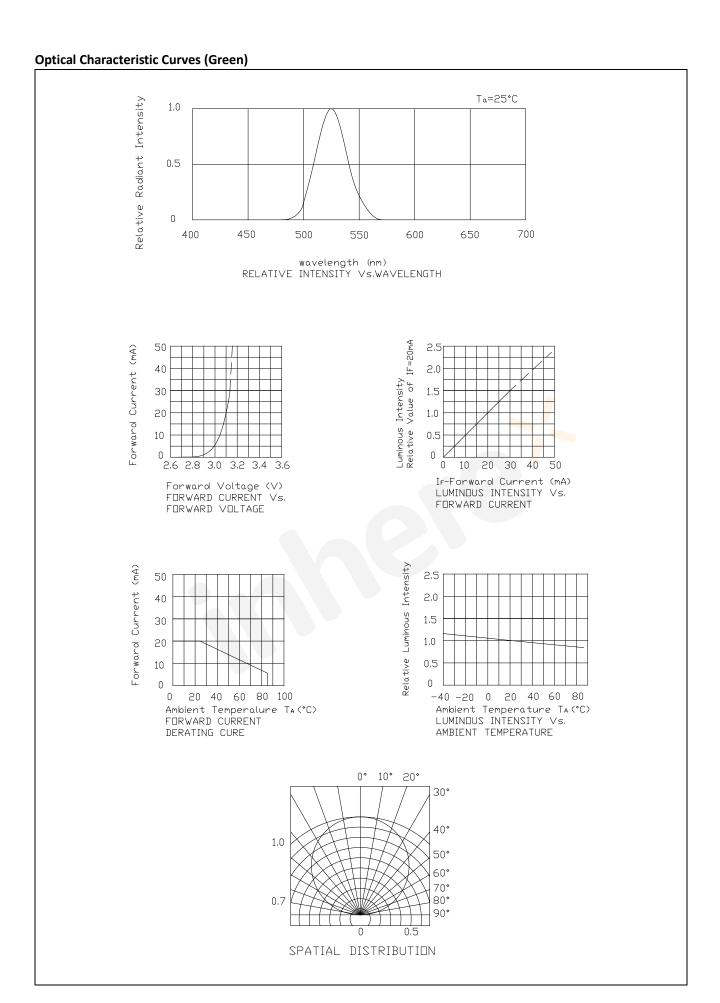
Electro-Optical Characteristics (Ta=25°C)

Parameter	Test	Symbol		Value			Unit
Farameter	Condition			Min	Тур	Max	Oilit
			R		630		
Wavelength at peak emission	If=20mA	λр	G		520		nm
			В		465		
			R		20		
Spectral half bandwidth	If=20mA	Δλ	G		35		nm
			В		25		
			R	620		630	
Dominant wavelength	If=20mA	λd	G	520		530	nm
			В	465		475	
			R	1.8		2.4	
Forward voltage	If=20mA	Vf	G	2.8		3.7	V
			В	2.8		3.7	
			R	100	180		
Luminous intensity	If=20mA	lv	G	320	500		mcd
			В	100	160		
Viewing angle at 50% Iv	If=10mA	2 θ 1,	/2		120		Deg
Reverse current	Vr=5V	lr			1	10	μΑ

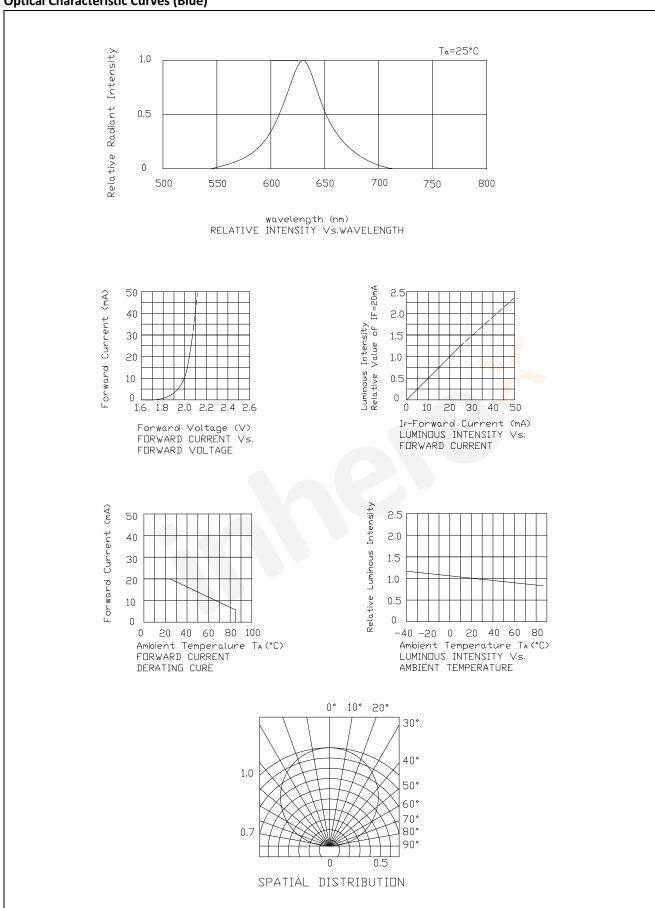
Part No.: S2012CHRGBT-001 Prepared by: Lily Rev.: A Checked by: Tom

Optical Characteristic Curves (Red)



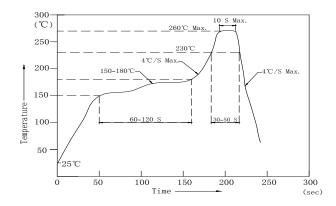


Optical Characteristic Curves (Blue)



Reflow Profile

■ Reflow Temp/Time



Notes:

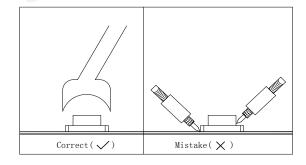
- 1. We recommend the reflow temperature 245 $^{\circ}$ C (±5 $^{\circ}$ C).the maximum soldering temperature should be limited to 260 $^{\circ}$ C.
- 2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

■Soldering iron

Basic spec is \leq 5sec when 320°C (±20°C). If temperature is higher, time should be shorter (+10°C \rightarrow -1sec). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under 350°C.

■Rework

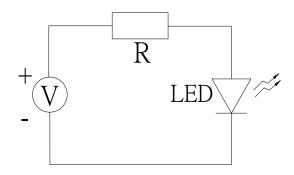
- 1. Customer must finish rework within 5 sec under 340°C.
- 2. The head of iron cannot touch copper foil
- 3. Twin-head type is preferred.



■ Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

Test circuit and handling precautions

■ Test circuit



■ Handling precautions

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: 5°C~30°C

2.2 Shelf life in sealed bag: 12 month at $<5^{\circ}\text{C}^{\sim}30^{\circ}\text{C}$ and <30% R.H. after the package is opened, the products should be used within a week or they should be keeping to stored at \leq 20 R.H. with zip-lock sealed.

3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

- 3.1 60 ± 3 °C x(12~24hrs) and <5%RH, taped reel type
- 3.2 100±3°C x (45min~1hr), bulk type
- 3.3 130±3°C x (15~30min), bulk type

Test Items and Results of Reliability

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Test Item	Test Conditions	Standard Test Method	Note	Number of Test
Reflow Soldering	Ta=260±5 °C ,Time=10±2S	JB/T 10845-2008	3times	0/22
Salt Atmosphere	Ta=35±3℃,PH=6.5~7.2	GB/T 2423.17-2008	24hrs	0/22
Temperature Cycling	-40±5°C 30±1min ↑→(25°C/5±1min)↓ 100±5°C 30±1min	GB/T 2423.22-2012	100cycles	0/22
Thermal Shock	Ta=- 40 ± 5 $^{\circ}$ C \sim 100 ± 5 $^{\circ}$ C, 15 ± 1 min dwell	GB/T 2423.22-2012	100cycles	0/22
High Humidity High Temp. Cycling	Ta=30 \pm 5 $^{\circ}$ C \sim 65 \pm 5 $^{\circ}$ C, 90 \pm 5%RH,24hrs/1cycle	GB/T 2423.4-2008	10cycles	0/22
High Humidity High Temp. Storage Life	Ta=85±5℃,ψ(%)=85±5%RH	GB/T 2423.3-2006	1000hrs	0/22
High Temperature Storage Life	Ta=100±5℃,non-operating	GB/T 2423.2-2008	1000hrs	0/22
Low Temperature Storage Life	Ta=-40±5℃,non-operating	GB/T 2423.1-2008	1000hrs	0/22
Life Test	Ta=26±5˚C ,@20mA, ψ(%)=25%RH~55%RH		1000hrs	0/22
High Humidity High Temp. Operating Life	Ta=85±5˚C ,@20mA, ψ(%)=85%RH	GB/T 2423.3-2006	500hrs	0/22
Low Temperature Operating Life	Ta=-20±5℃,@20mA	GB/T 2423.1-2008	1000hrs	0/22

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Forward Voltage Rank Combination (IF=20mA)

Rank		Min.	Max.	Unit
Red		1.8	2.4	
	f	2.8	3.1	
Green	g	3.1	3.4	
	h	3.4	3.7	V
	f	2.8	3.1	
Blue	g	3.1	3.4	
	h	3.4	3.7	

Luminous Intensity Rank Combination (IF=20mA)

Rank		Min.	Max.	Unit
	J	100	125	
	К	125	160	
Dod	L	160	200	
Red	M	200	250	
	N	250	320	
	0	320)	
	0	320	400	
	Р	400	500	med
Green	Q	500	630	mcd
	R	630	800	
	S	800	1	
	J	100	125	
	К	125	160	
Blue	L	160	200	
	М	200	250	
	N	250		

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Dominant wavelength Rank Combination (IF=20mA)

Rank		Min.	Max.	Unit
Dod	t	620	625	
Red	u	625	630	
	U	520	522.5	
Grann	V	522.5	525	
	W	525	527.5	
	Х	527.5	530	nm
	G	465	467.5	
Dlue	н	467.5	470	/
Blue		470	472.5	
	J	472.5	475	

Group Name on Label	(Example DATA:	□Kt	gPV	gKG 20)
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DATA:	Kt gPV gKG 20	Vf(V)	lv (mcd)	λd (nm)	Test Condition
Red	□ → K → t → 20	1.8~2.4	125~160	620~625	
Green	g → P→V→20	3.1~3.4	400~500	522.5~525	IF=20mA
Blue	g → K → G → 20	3.1~3.4	125~160	465~467.5	

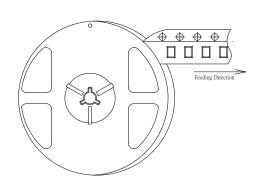
Notes:

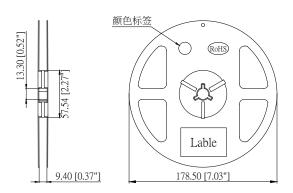
- 1.The tolerance of luminous intensity (Iv)is $\pm 15\,\%$.
- 2. The tolerance of dominant wavelength is ± 1 nm.
- 3. This specification is preliminary.
- 4. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

2012 Series SMD Chip LED Lamps Packaging Specifications

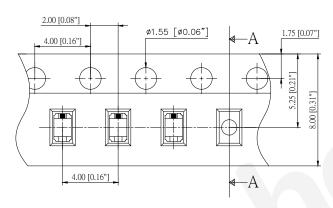
Feeding Direction

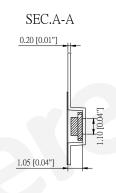
Dimensions of Reel (Unit: mm)



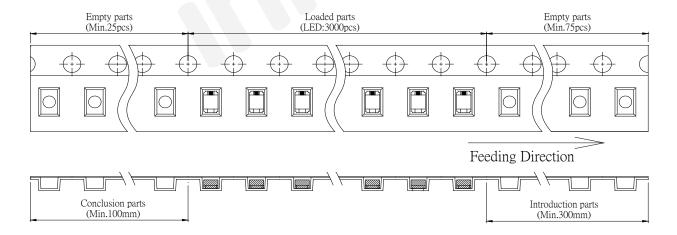


Dimensions of Tape (Unit: mm)





Arrangement of Tape



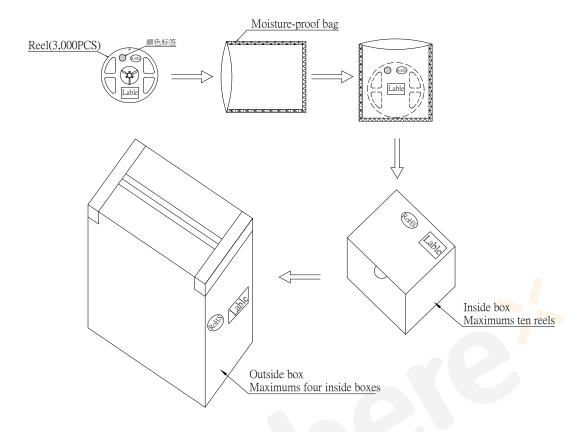
Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
- 4. 3,000pcs/Reel.

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2012 Series SMD Chip LED Lamps Packaging Specifications

Packaging specifications



Notes:

Reeled products (numbers of products are 3,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, ten moisture-proof bag of maximums (total maximum number of products are 30,000pcs) packed in an inside box (about size: 240x 230x 130mm) and four inside boxes of maximums are put in the outside box (about size: 545mm x260mm x 250mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.

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